SamHop Microelectronics Corp.

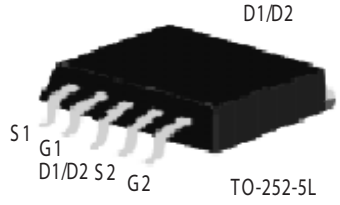
STU405D

Nov,24 2005

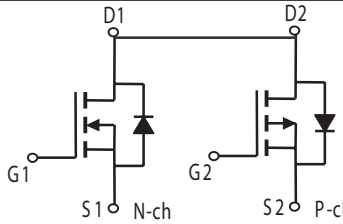
Dual Enhancement Mode Field Effect Transistor (N and P Channel)

PRODUCT SUMMARY (N-Channel)		
V_{DSS}	I_D	$R_{DS(ON)}$ (mΩ) Max
40V	16A	30 @ V_{GS} = 10V
		40 @ V_{GS} = 4.5V

PRODUCT SUMMARY (P-Channel)		
V_{DSS}	I_D	$R_{DS(ON)}$ (mΩ) Max
-40V	-12A	48 @ V_{GS} = -10V
		65 @ V_{GS} = -4.5V



TO-252-5L



ABSOLUTE MAXIMUM RATINGS (T_A=25°C unless otherwise noted)

Parameter		Symbol	N-Channel	P-Channel	Unit
Drain-Source Voltage		V_{DS}	40	-40	V
Gate-Source Voltage		V_{GS}	±20	±20	V
Drain Current-Continuous @Tc	25°C	I_D	16	-12	A
	70°C		13.8	-10	A
-Pulsed [a]		I_{DM}	50	-50	A
Drain-Source Diode Forward Current		I_S	8	-6	A
Maximum Power Dissipation	Tc= 25°C	P_D	11		W
	Tc= 70°C		7.7		
Operating Junction and Storage Temperature Range		T_J, T_{STG}	-55 to 175		°C

THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	13.6	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	120	°C/W

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N-Channel ELECTRICAL CHARACTERISTICS (T_A = 25 °C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ [c]	Max	Unit
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}=0V, I_D=250uA	40			V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=32V, V_{GS}=0V			1	uA
Gate-Body Leakage	I_{GSS}	V_{GS}=±20V, V_{DS}=0V			±100	nA
ON CHARACTERISTICS [a]						
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS}, I_D=250uA	1	1.8	3	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	V_{GS}=10V, I_D=8A		22	30	m ohm
		V_{GS}=4.5V, I_D=6A		30	40	m ohm
On-State Drain Current	$I_{D(ON)}$	V_{DS}=5V, V_{GS}=4.5V	20			A
Forward Transconductance	g_{FS}	V_{DS}=10V, I_D=8A		20		S
DYNAMIC CHARACTERISTICS [b]						
Input Capacitance	C_{ISS}	V_{DS}=25V, V_{GS}=0V f=1.0MHz		885	1050	pF
Output Capacitance	C_{OSS}			105		pF
Reverse Transfer Capacitance	C_{RSS}			65		pF
Gate resistance	Rg	V_{GS}=0V, V_{DS}=0V, f=1.0MHz		0.32		ohm
SWITCHING CHARACTERISTICS [b]						
Turn-On Delay Time	$t_{D(ON)}$	V_{DD}=20V I_D=1 A V_{GS}=10V R_{GEN}=3.3 ohm		16		ns
Rise Time	t_r			12		ns
Turn-Off Delay Time	$t_{D(OFF)}$			28		ns
Fall Time	t_f			7		ns
Total Gate Charge	Q_g	V_{DS}=28V, I_D=8A, V_{GS}=10V		17		nC
		V_{DS}=28V, I_D=8A, V_{GS}=4.5V		8.6		nC
Gate-Source Charge	Q_{gs}	V_{DS}=28V, I_D=8 A V_{GS}=10V		2.2		nC
Gate-Drain Charge	Q_{gd}			4.8		nC

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P-Channel ELECTRICAL CHARACTERISTICS (T_A = 25 °C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ [c]	Max	Unit
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}=0V, I_D=-250uA	-40			V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=-32V, V_{GS}=0V			-1	uA
Gate-Body Leakage	I_{GSS}	V_{GS}=±20V, V_{DS}= 0V			±100	nA
ON CHARACTERISTICS [a]						
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS}, I_D=-250uA	-1	-1.6	-3	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	V_{GS}=-10V, I_D= -6A		40	48	m ohm
		V_{GS}=-4.5V, I_D= -4A		50	65	m ohm
On-State Drain Current	$I_{D(ON)}$	V_{DS}= -5V, V_{GS}= -10V	-20			A
Forward Transconductance	g_{FS}	V_{DS}= -10V, I_D=-6A		12		S
DYNAMIC CHARACTERISTICS [b]						
Input Capacitance	C_{ISS}	V_{DS}=-25V, V_{GS}= 0V f=1.0MHz		980	1150	pF
Output Capacitance	C_{OSS}			135		pF
Reverse Transfer Capacitance	C_{RSS}			90		pF
Gate resistance	Rg	V_{GS}=0V, V_{DS}= 0V, f=1.0MHz		2.2		ohm
SWITCHING CHARACTERISTICS [b]						
Turn-On Delay Time	$t_{D(ON)}$	V_{DD} = -20V I_D = -1A V_{GS} = -10V R_{GEN} = 3.3 ohm		12		ns
Rise Time	t_r			17		ns
Turn-Off Delay Time	$t_{D(OFF)}$			82		ns
Fall Time	t_f			35		ns
Total Gate Charge	Q_g	V_{DS}=-28V, I_D=-6A,V_{GS}=-10V		20.7		nC
		V_{DS}=-28V, I_D=-6A,V_{GS}=-4.5V		11		nC
Gate-Source Charge	Q_{gs}	V_{DS}=-28V, I_D= -6 A V_{GS}=-10V		1.5		nC
Gate-Drain Charge	Q_{gd}			6.2		nC

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ELECTRICAL CHARACTERISTICS (T_A=25°C unless otherwise noted)

Parameter	Symbol	Condition		Min	Typ [c]	Max	Unit
DRAIN-SOURCE DIODE CHARACTERISTICS [b]							
Diode Forward Voltage	V_{SD}	V_{GS} = 0V, Is =8A	N-Ch		0.98	1.2	V
		V_{GS} = 0V, Is =-6A	P-Ch		-0.9	-1.2	

Notes

a.Pulse Test:Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.

b.Guaranteed by design, not subject to production testing.

N-Channel

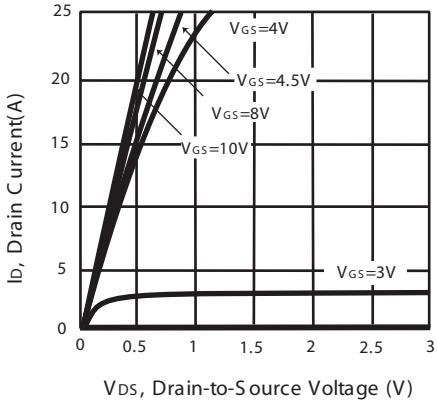

Figure 1. Output Characteristics

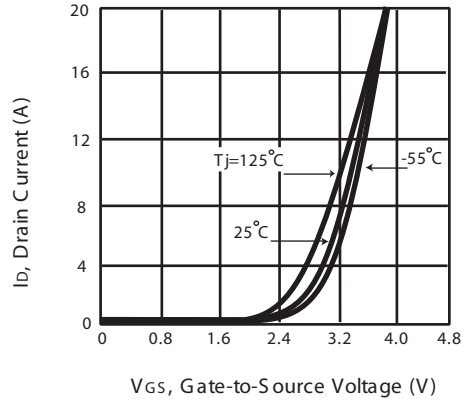

Figure 2. Transfer Characteristics

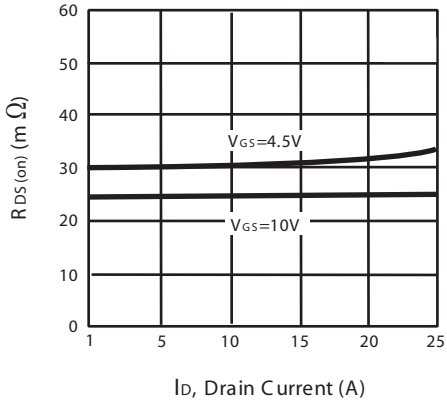

Figure 3. On-Resistance vs. Drain Current and Gate Voltage

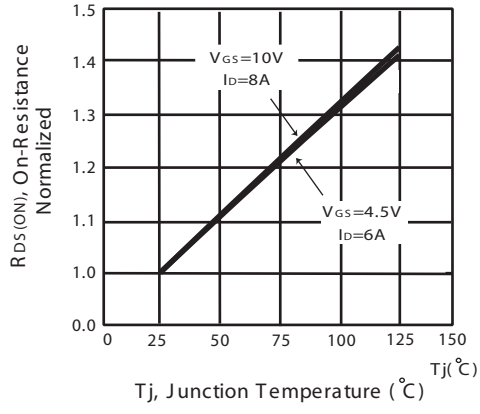

Figure 4. On-Resistance Variation with Drain Current and Temperature

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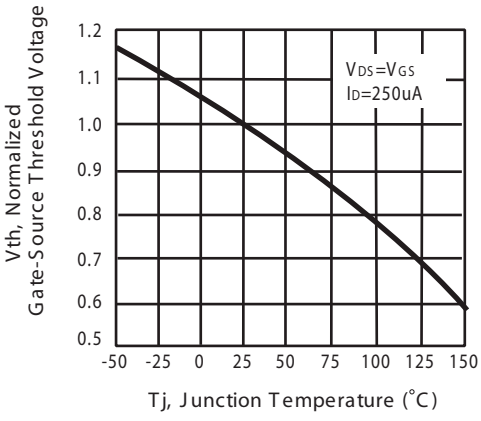

Figure 5. Gate Threshold Variation with Temperature

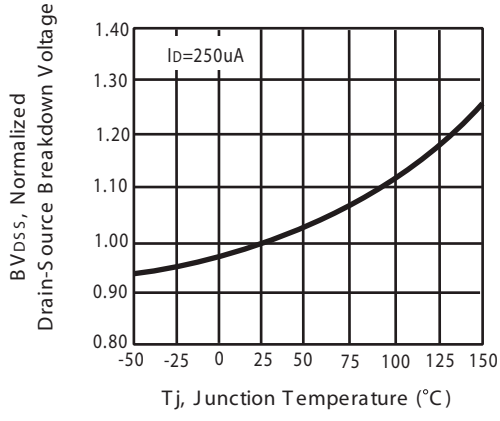

Figure 6. Breakdown Voltage Variation with Temperature

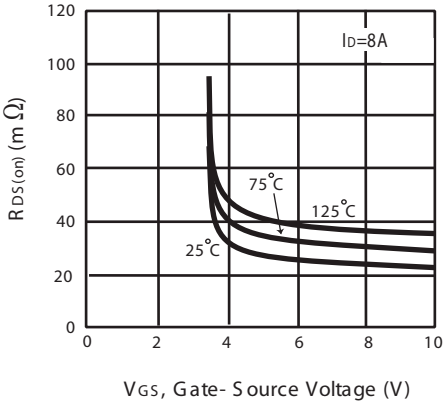

Figure 7. On-Resistance vs. Gate-Source Voltage

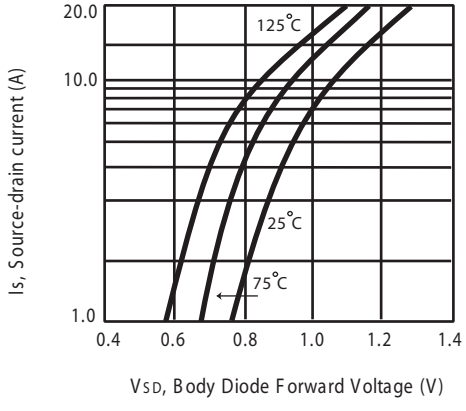

Figure 8. Body Diode Forward Voltage Variation with Source Current

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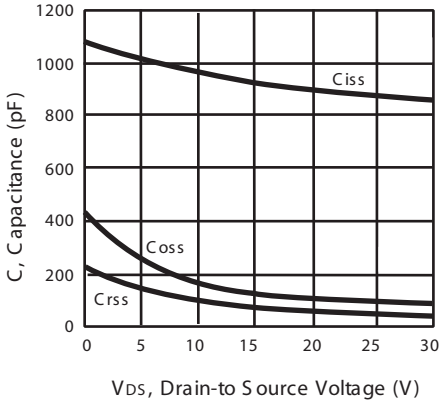

Figure 9. Capacitance

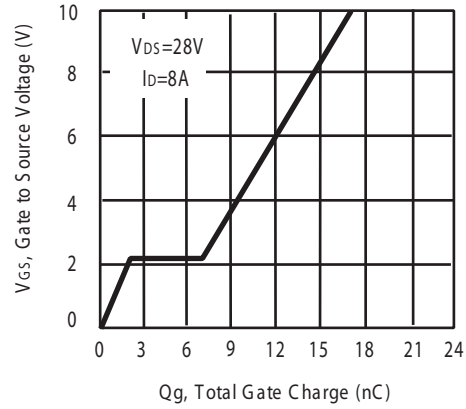

Figure 10. Gate Charge

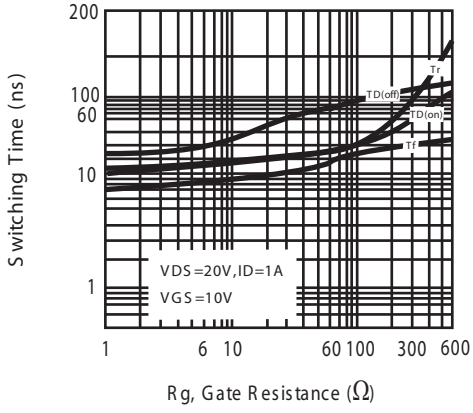

Figure 11.switching characteristics

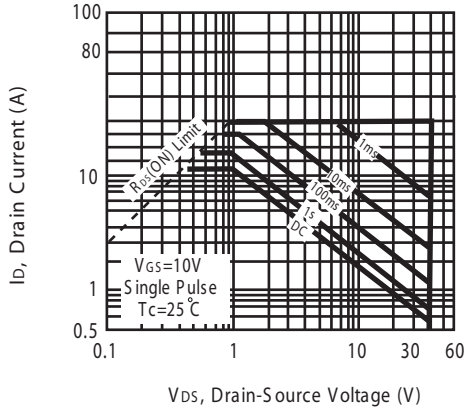

Figure 12. Maximum Safe Operating Area

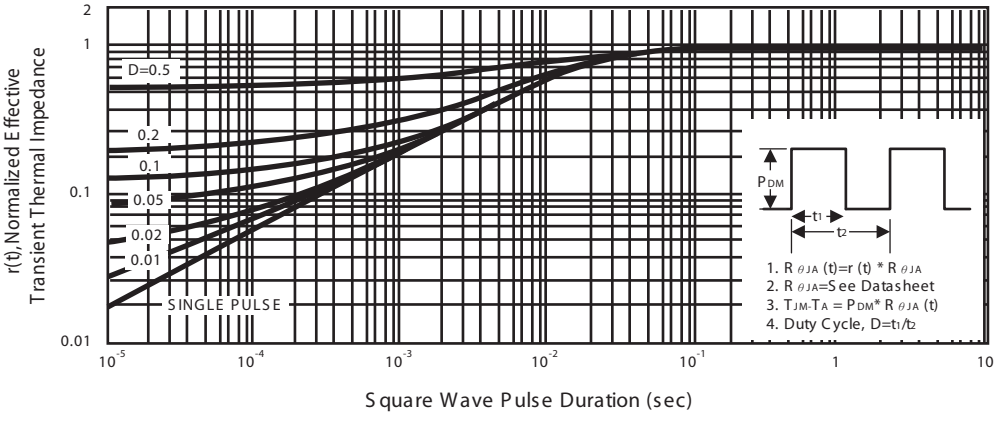

Figure 13. Normalized Thermal Transient Impedance Curve

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P-Channel

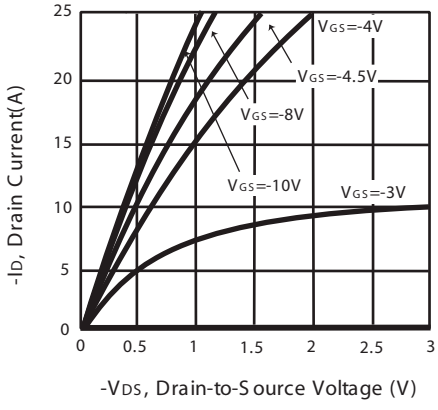


Figure 1. Output Characteristics

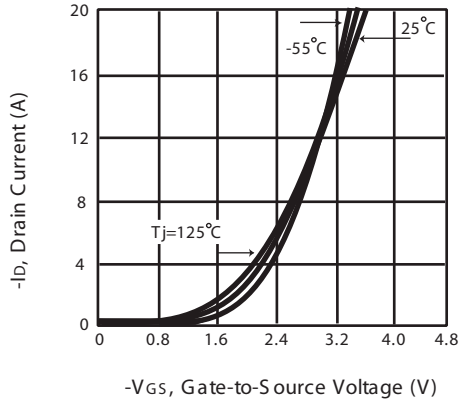
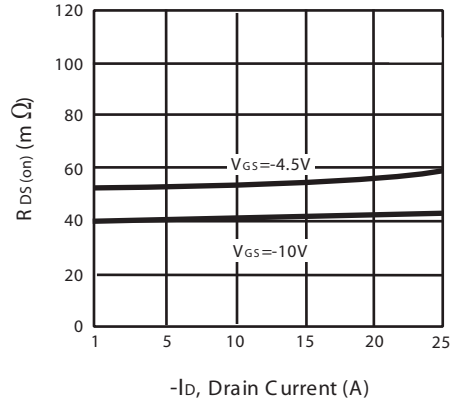


Figure 2. Transfer Characteristics



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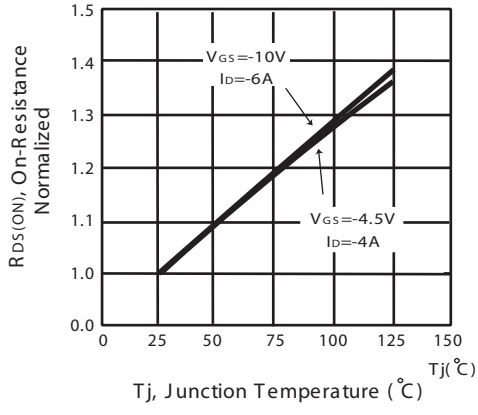

Figure 4. On-Resistance Variation with Drain Current and Temperature

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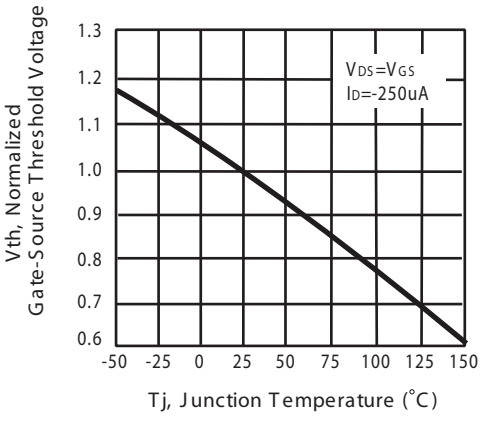

Figure 5. Gate Threshold Variation with Temperature

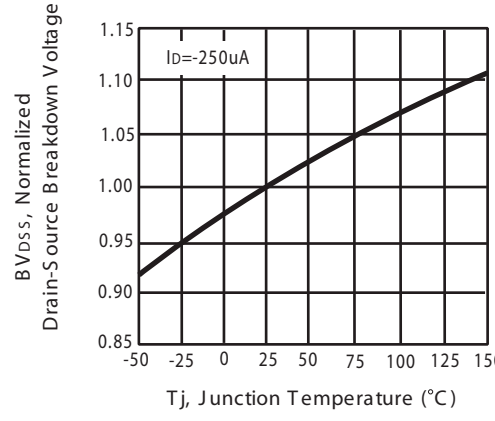

Figure 6. Breakdown Voltage Variation with Temperature

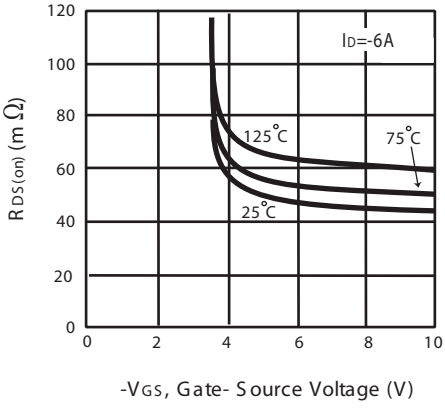

Figure 7. On-Resistance vs. Gate-Source Voltage

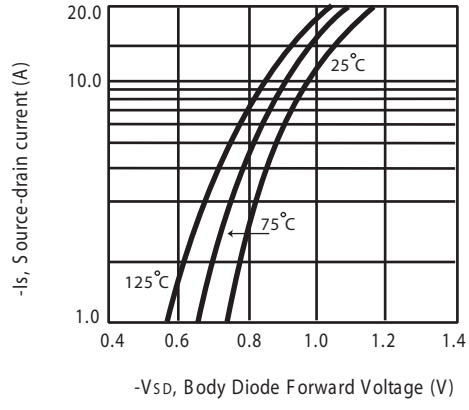

Figure 8. Body Diode Forward Voltage Variation with Source Current

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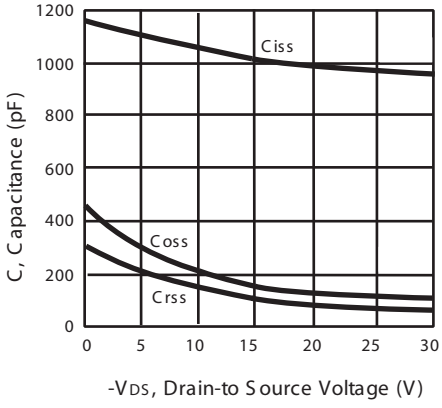

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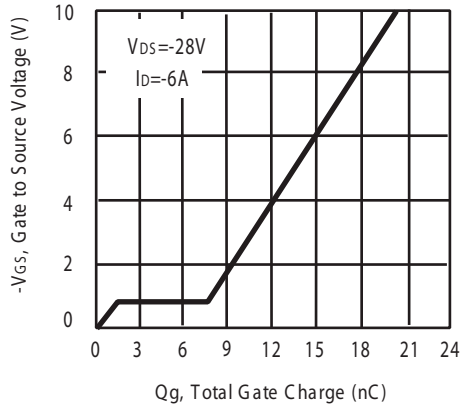

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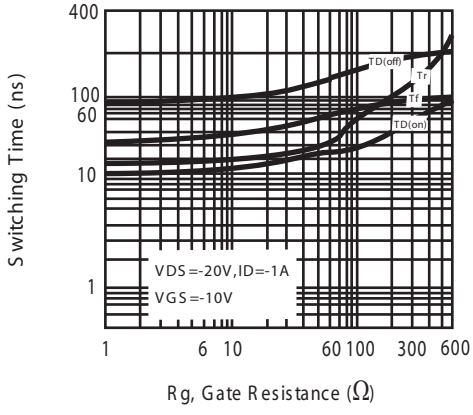

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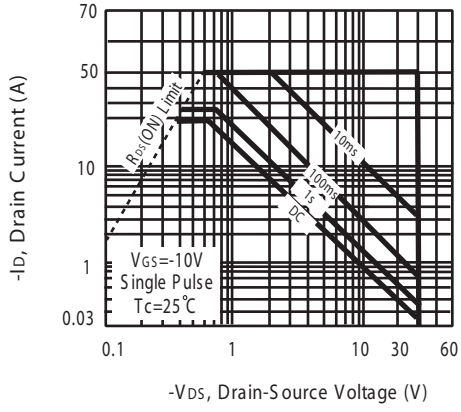

Figure 12. Maximum Safe Operating Area

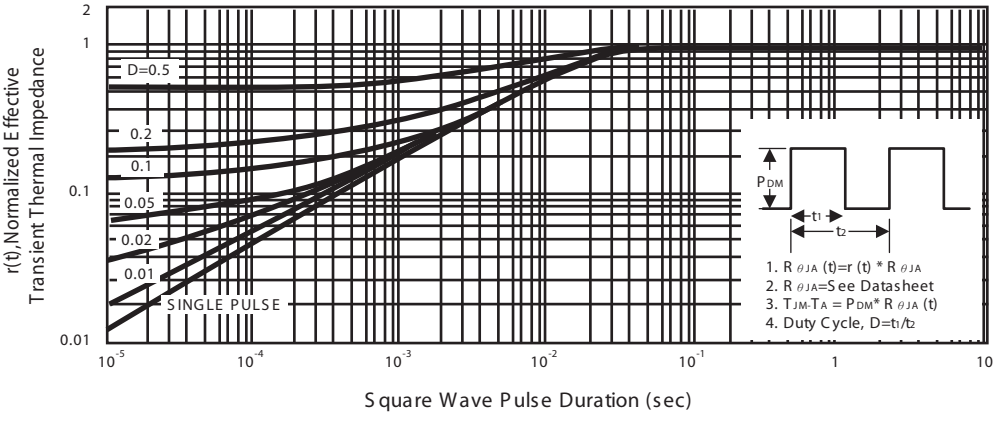

Figure 13. Normalized Thermal Transient Impedance Curve

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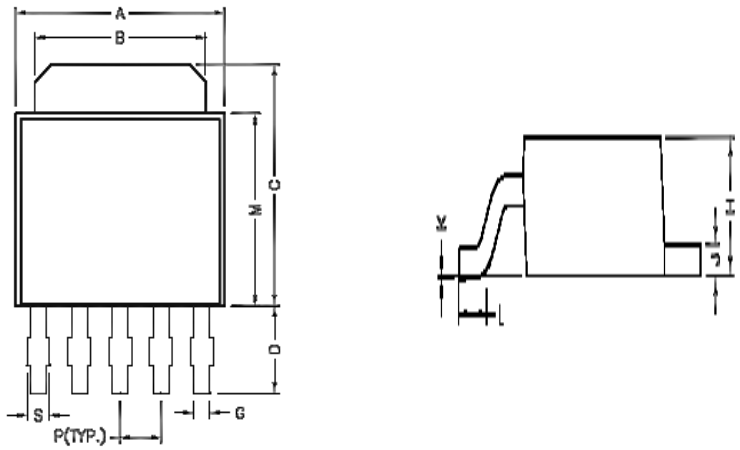
PACKAGE OUTLINE DIMENSIONS

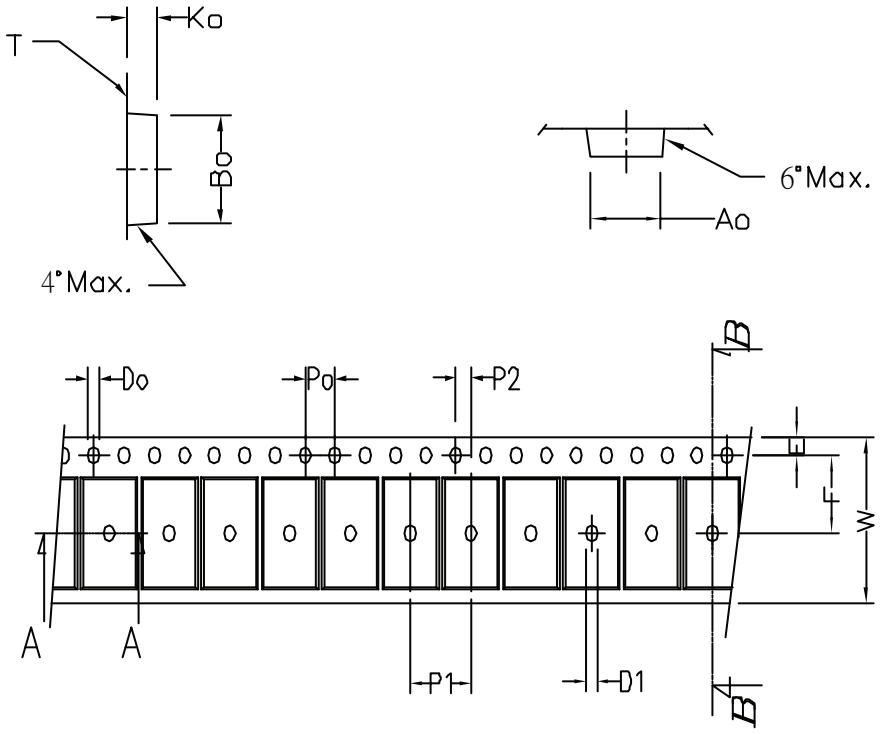
TO-252-5L



REF .	Millimeters		REF .	Millimeters	
	MIN	MAX		MIN	MAX
A	6.40	6.80	G	0.40	0.60
B	5.20	5.50	H	2.2	2.40
C	6.80	7.20	J	0.45	0.55
D	2.20	2.80	K	0	0.15
P	1.27 REF.		L	0.90	1.50
S	0.50	0.80	M	5.40	5.80

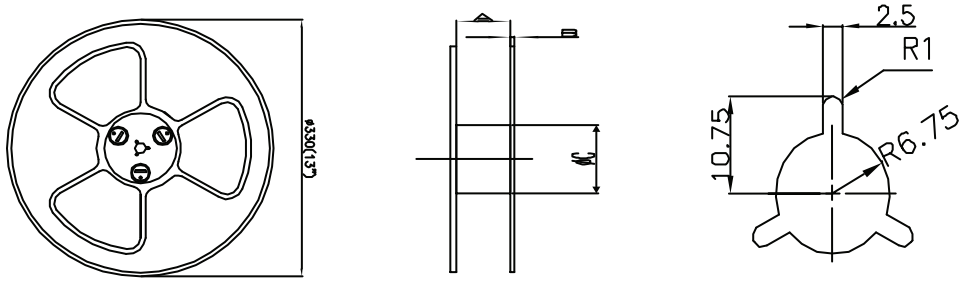
TO-252-5L Tape and Reel Data

TO-252-5L Carrier Tape



symbol	Ao	Bo	Ko	Po	P1	P2	T
Spec	6.96±0.1	10.49±0.1	2.79±0.1	4.0±0.1	8.0±0.10	2.0±0.05	0.33±0.013
symbol	E	F	Do	D1	W	10Po	
Spec	1.75±0.1	7.5±0.05	1.55±0.05	1.5±0.25	$16.0^{+0.3}_{-0.1}$	40.0±0.2	

TO-252-5L Reel



UNIT:㎜

Width of carrier tape	8	12	16	24	32	44	56
A±0.1	9.4	13.4	17.4	25.4	33.4	45.4	57.4
B	2.3	2.3	2.3	2.3	2.3	2.3	2.3
øC	100	100	100	100	100	100	100